
Expand your capabilities for discovery.
ZEISS Xradia 410 Versa
ZEISS
Seeing beyond

A Workhorse Solution for Your 3D Submicron Imaging

ZEISS Xradia 410 Versa bridges the gap between high-performing X-ray microscopes and less powerful, lower-cost micro-computed tomography (microCT) systems. Delivering non-destructive 3D imaging with industry best resolution, contrast, and *in situ* capabilities, ZEISS Xradia 410 Versa enables you to achieve groundbreaking research for the widest range of sample sizes. Enhance imaging workflows with this powerful, cost-efficient "workhorse" solution, even in diverse lab environments.

Simpler. More Intelligent. More Integrated.

Extend the Boundaries of Science

ZEISS Xradia 410 Versa X-ray microscope delivers cost-efficient, flexible 3D imaging to enable you to address a wide range of samples and research environments. Non-destructive X-ray imaging preserves and extends the use of your valuable samples over time. The instrument achieves 0.9 µm true spatial resolution with minimum achievable voxel size of 100 nm. Advanced absorption and phase contrast (for soft or low-Z materials) offer you more versatility to overcome the limitations of traditional computed tomography approaches.

Achieve Performance Beyond MicroCT

ZEISS Xradia Versa solutions extend scientific research beyond the limits of projection-based micro- and nanoCT systems. Where traditional tomography relies on a single stage of geometric magnification, ZEISS Xradia 410 Versa features a unique two-stage process based on synchrotron-caliber optics. You will find it easy to use, with flexible contrast, while its breakthrough Resolution at a Distance (RaaD) enables you to achieve unprecedented lab-based exploration for a diverse array of applications, sample types and sizes. And, multi-length scale capabilities enable you to image the same sample across a wide range of magnifications. Additionally, the Scout-and-Scan control system enables an efficient workflow environment with recipe-based setup that makes ZEISS Xradia 410 Versa easy for users with a wide variety of experience levels. Accelerate post-processing and image segmentation tasks using advanced machine learning with ZEISS ZEN Intellesis. Boost throughput and image quality with ZEISS DeepRecon Pro and OptiRecon, advanced reconstruction technologies leveraging artificial intelligence and iterative algorithms.

Your Premier 4D / *In Situ* Solution

Non-destructive X-ray microscopes allow you to uniquely characterize the microstructure of materials in their native environments – *in situ* – as well as to understand the evolution of properties over time (4D). RaaD capabilities enable you to maintain submicron resolution across a broad spectrum of sample dimensions in native environments and to use a wide range of *in situ* rigs. The ZEISS Xradia Versa *In Situ* Kit makes set-up optimal and operation easy with a faster time to results.

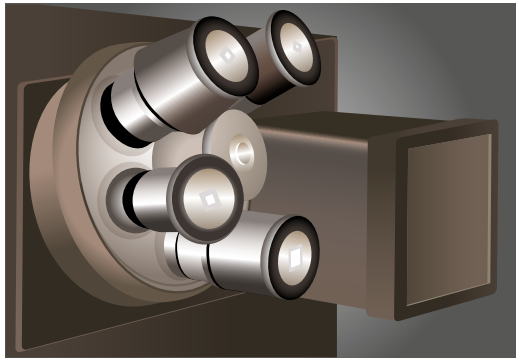
Your Insight into the Technology Behind It

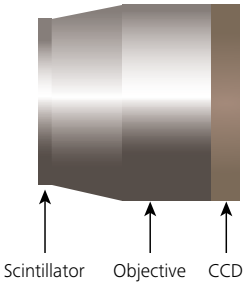
Today's science requires three-dimensional insight into subjects in their native states and as they evolve over time. World-leading research facilities, universities, synchrotrons, national and private labs continue to deploy X-ray microscopy to meet the growing need for flexible 3D/4D imaging at high resolution.

X-ray microscopy plays a vital role in your imaging workflow, delivering high resolution and contrast without destroying valuable samples for future use. Adding a non-destructive stage to the traditional workflow complements electron and optical techniques used in prominent labs worldwide, enabling you to quickly identify regions of interest for further study with destructive techniques.

ZEISS Xradia Versa solutions employ sophisticated X-ray optics developed for synchrotrons and a unique system architecture. Along with superior resolution and contrast, ZEISS Xradia Versa allow you to perform unique multi-length scale imaging using flexible working distances and workflow efficiencies for a diverse array of applications and samples.

XRM Detector Technology



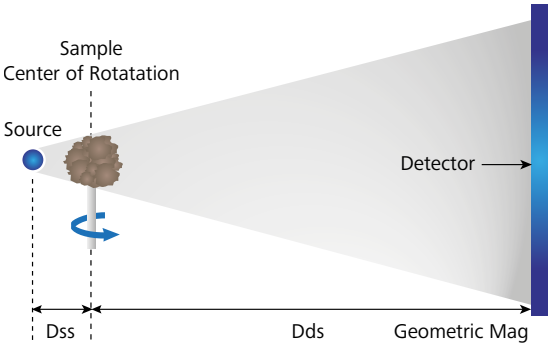


Your Insight into the Technology Behind It

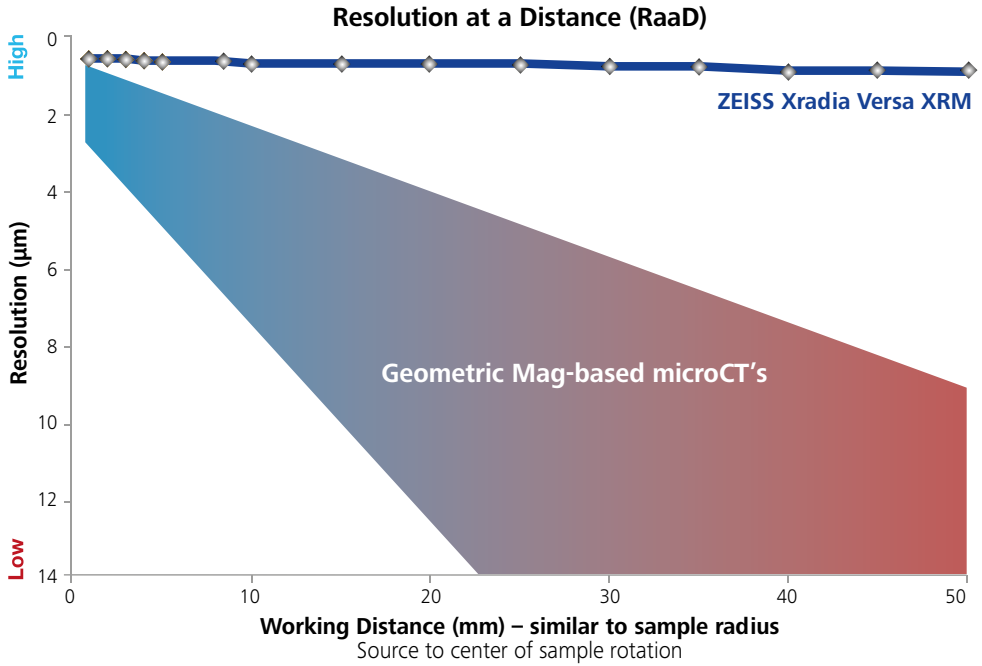
ZEISS XRM: Architected for Your Advantage

Use the two-stage magnification technique offered by ZEISS Xradia Versa to uniquely achieve RaaD, which enables you to effectively study the widest range of sample sizes, including those within *in situ* chambers.

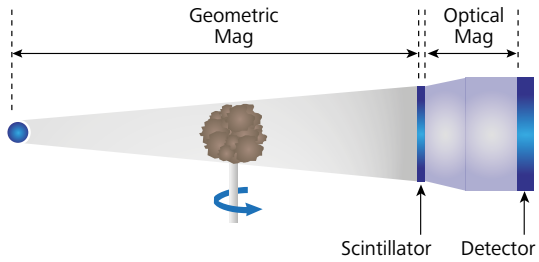
Your sample images are initially enlarged through geometric magnification as they are in conventional microCT. In the second stage, a scintillator converts X-rays to visible light, which is then optically magnified. Reducing dependence upon geometric magnification enables ZEISS Xradia 410 Versa solutions to maintain submicron resolution down to 900 nm at large working distances.



Conventional Micro-CT Architecture



High resolution is maintained for large samples



ZEISS XRM Two-stage Magnification Architecture

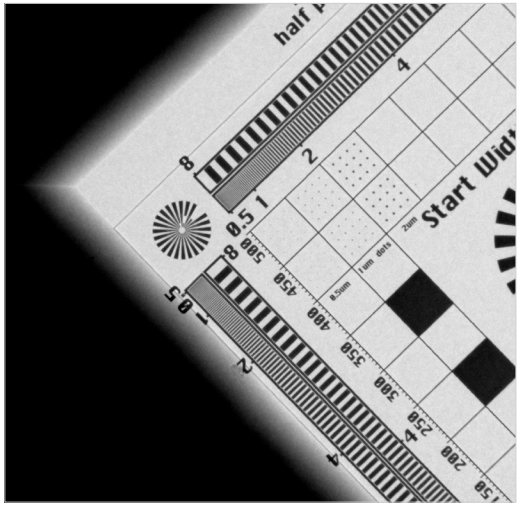
Your Insight into the Technology Behind It

Achieving True Resolution

ZEISS Xradia Versa solutions enable you to achieve powerful 3D X-ray imaging, maintaining true submicron spatial resolution across varying distances, sample sizes, and environments. ZEISS XRM are specified on true spatial resolution, the most meaningful measurement of a microscope's performance.

Spatial resolution refers to the minimum separation at which you can resolve a feature pair with an imaging system. It is typically measured by imaging a standardized resolution target with progressively smaller line-space pairs.

Spatial resolution accounts for critical characteristics such as X-ray source spot size, detector resolution, magnification geometry, and vibrational, electrical, and thermal stability. Other terms such as "voxel," "spot size," "detail detectability," and "nominal resolution" do not provide you with an understanding of full system performance.



	Resolution on Traditional microCT Systems	Higher Resolution on ZEISS 3D X-ray Microscope (XRM)
Spot size	Suffer from spot-size dependent blur.	Unique dual-stage magnification enables performance not limited by spot size
Sample size	Only able to achieve high resolution on smallest sample sizes.	ZEISS XRM Resolution-at-a-Distance (RaaD) technology enables highest resolution across diverse sample sizes and working distances.
Sample type	Limited to small, low-Z samples using low kV X-ray beam	Energy-tuned detectors enable highest resolution across broad ranges of sample types and densities.
Instrument setup	Require installation of different source targets/ filaments for different operating needs	Source is designed to operate across the entire application space with a wide range of detectors, eliminating the need for manual hardware reconfigurations

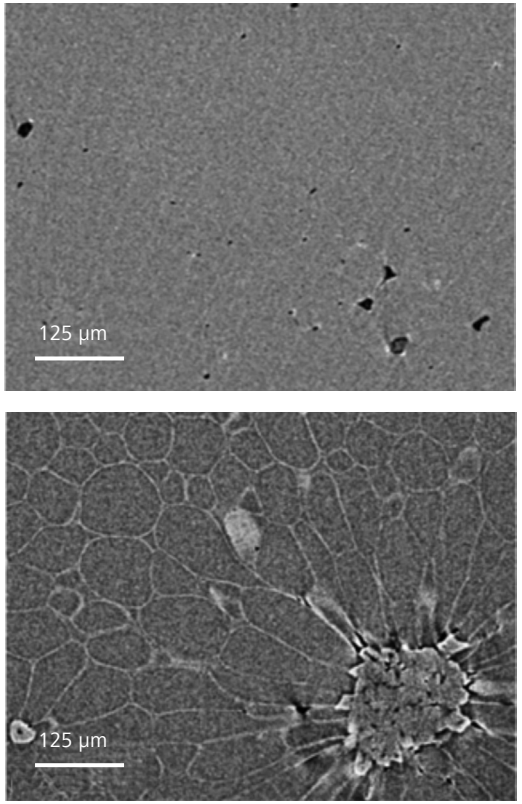
Your Insight into the Technology Behind It

Gain an Edge in Contrast

Your imaging requires superior contrast capabilities to reveal details you need to visualize and quantify features. ZEISS Xradia Versa deliver flexible, high contrast imaging for even your most challenging materials – low atomic number (low Z) materials, soft tissue, polymers, fossilized organisms encased in amber, and other materials of low contrast.

Our comprehensive approach employs proprietary enhanced absorption contrast detectors that provide you with superior contrast by maximizing collection of low energy photons while minimizing collection of contrast-reducing high energy photons.

In addition, tunable propagation phase contrast measures the refraction of X-ray photons at material transitions to allow you to visualize features displaying little or no contrast during absorption imaging.



Pear imaged with absorption contrast – no visibility of cell walls (top), and pear imaged with phase contrast, showing details of cell walls in normal cells and stone cells (bottom).

Your Insight into the Technology Behind It

Advanced Reconstruction Toolbox

The Advanced Reconstruction Toolbox is an innovative platform on which you can continuously access state-of-the-art reconstruction technologies from ZEISS to enrich your research and increase the return on investment of your ZEISS Xradia 3D XRM.

These unique offerings from ZEISS leverage deep understanding of both X-ray physics and customer applications to solve some of the hardest imaging challenges in new and innovative ways. These optional modules are workstation-based solutions that provide easy access and usability.

	FDK Standard Analytical Reconstruction	**OptiRecon** Iterative Reconstruction	**DeepRecon Pro** AI (Deep-Learning) based Reconstruction
Throughput	1×	up to 4×	up to 10×
Image Quality*	Standard	Better	Best
Ease-of-Use	Minimal	Requires parameter optimization	One-click setup
Applicability	Repetitive and non-repetitive workflows		

* Image quality refers to the contrast-to-noise ratio and the relative performance of reconstruction technologies is shown.

ZEISS DeepRecon

The first commercially available deep learning reconstruction technology enables you to increase throughput by up to 10× without sacrificing novel XRM RaaD. Alternatively, keep the same number of projections and enhance the image quality further. DeepRecon uniquely harvests the hidden opportunities in big data generated by your XRM and provides significant AI-driven speed or image quality improvement.

ZEISS offers DeepRecon technology in 2 forms – 1) DeepRecon Pro, and 2) DeepRecon Custom – both leveraging AI to provide unprecedented image quality with unparalleled speed.

ZEISS DeepRecon Pro is an innovative AI-based technology bringing superior throughput and image quality benefits across a wide range of applications. DeepRecon Pro is applicable to both unique samples as well as semi-repetitive and repetitive workflows. Customers can now self-train new machine learning network models on-site with an extremely easy-to-use interface. The one-click workflow of DeepRecon Pro eliminates the need for a machine learning expert and can be seamlessly operated by even a novice user. ZEISS DeepRecon Custom is targeted specifically for repetitive workflow applications to further boost XRM performance beyond DeepRecon Pro. Customers can closely collaborate with ZEISS to develop custom-created network models that precisely fits their repetitive application needs.

ZEISS OptiRecon

A fast and efficient algorithm-based technology that delivers iterative reconstruction from your desktop, allowing you to achieve up to 4× faster scan times or enhanced image quality with equivalent throughput.

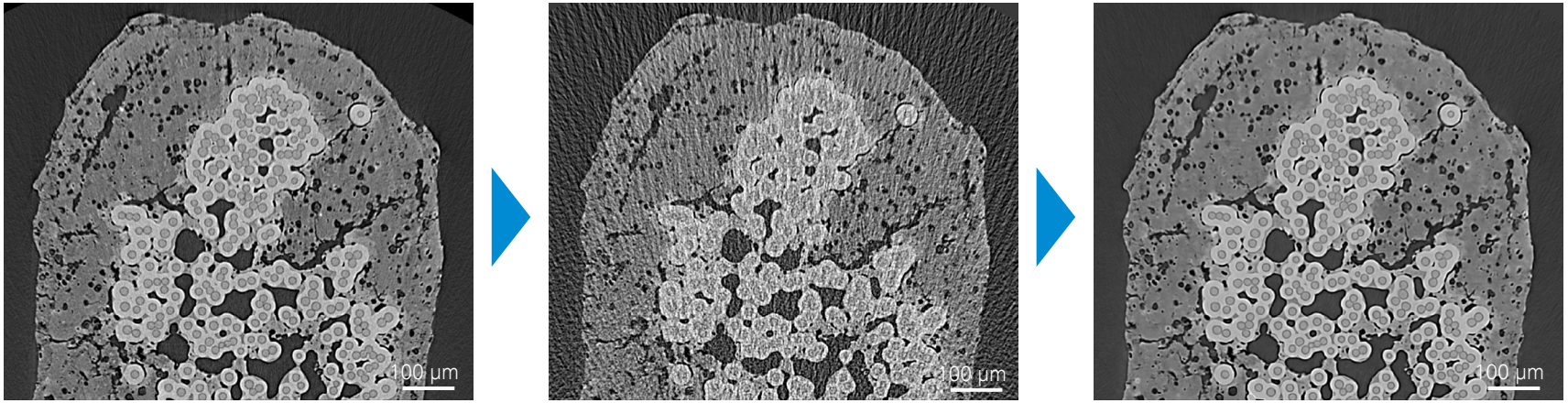
OptiRecon is an economical solution offering superior interior tomography or throughput on a broad class of samples.

ZEISS PhaseEvolve

ZEISS PhaseEvolve is a post-processing reconstruction algorithm that enhances the image contrast by revealing material contrast uniquely inherent to X-ray microscopy, which can often be obscured by phase effects in low-medium density samples or high resolution datasets. Perform more accurate quantitative analysis with improved contrast and segmentation of your results.

Your Insight into the Technology Behind It

ZEISS DeepRecon Pro – How It Works in Materials Science



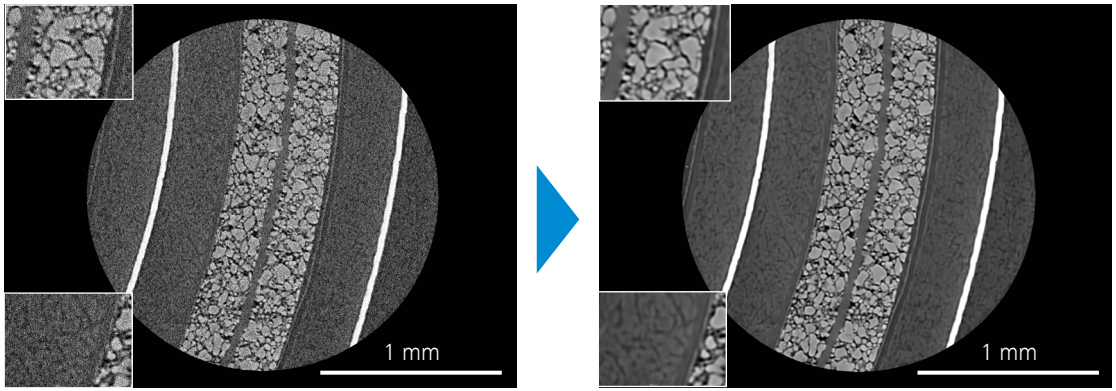
Standard reconstruction (FDK): Scan time 9 hrs (3001 projections)

Standard reconstruction (FDK): Scan time 53 mins (301 projections)

DeepRecon Pro: Scan time 53 mins (301 projections)

DeepRecon Pro used for throughput improvement for Ceramic Matrix Composite (CMC) sample, achieving 10× throughput improvement without sacrificing image quality. This would allow for much higher temporal resolution for in situ *studies.*

ZEISS DeepRecon Pro – How It Works in Electronics



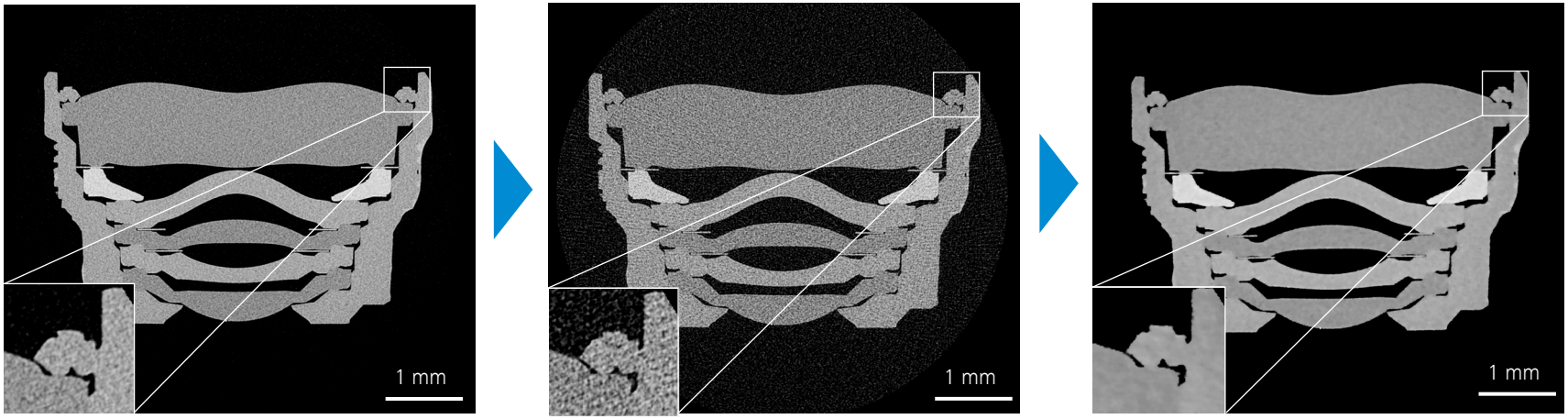
Standard Reconstruction (FDK)

DeepRecon Pro

DeepRecon Pro used for image quality improvement for a smartwatch battery. DeepRecon Pro both improves the clarity of cathode grains and polymer separator. It also allows for the recovery of features otherwise obscured by image noise, such as the electrolyte saturated anode.

Your Insight into the Technology Behind It

ZEISS OptiRecon – How It Works in Electronics



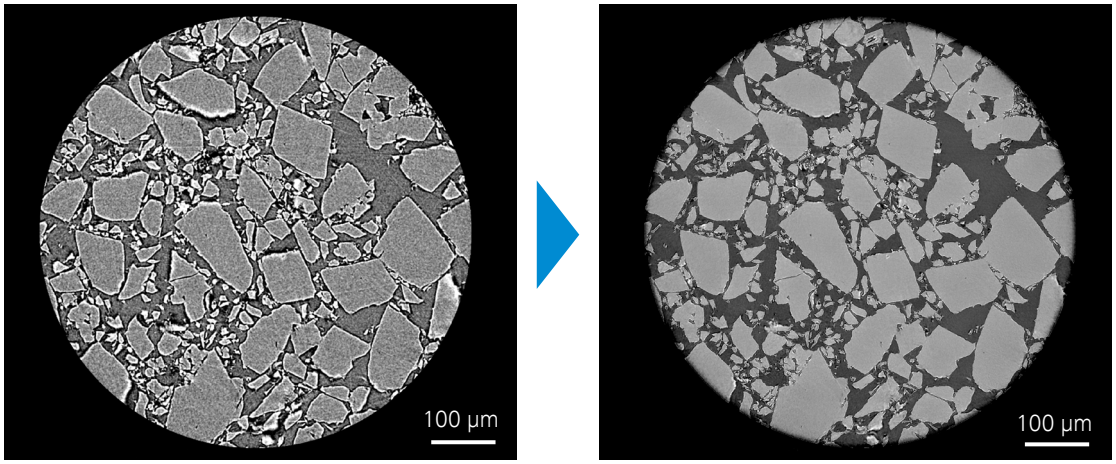
Standard reconstruction: Scan time 90 minutes (1200 projections)

Standard reconstruction: Scan time 22 minutes (300 projections)

OptiRecon: Scan time 22 minutes (300 projections)

Observe the performance of OptiRecon in a workflow performed on an electronics sample. Analyze integration issues in a smart phone camera lens, now 4× faster using OptiRecon.

ZEISS PhaseEvolve – How It Works in Materials Science



Standard reconstruction

PhaseEvolve applied reconstruction

Application of PhaseEvolve to a pharmaceutical powder sample. High resolution or low kV imaging can result in inherent material contrast being obscured by phase contrast artifacts. PhaseEvolve effectively removes phase fringes to enhance image contrast and improve segmentation results.

Your Insight into the Technology Behind It

Our Super Simple User Interface to Enables Efficient Workflows

All of the features introduced by the ZEISS Xradia 410 Versa are seamlessly integrated within the Scout-and-Scan Control System, an efficient workflow environment that allows you to easily scout a region of interest and specify scanning parameters. The easy-to-use system is ideal for a central lab-type setting where your users may have a wide variety of experience levels.

The interface maintains the flexibility for which ZEISS Xradia Versa systems are known, enabling you to setup scans even more easily. Scout-and-Scan software also offers recipe-based repeatability, which is especially useful for your *in situ* and 4D research, and enables you to have greater control and efficiency for future work.

Set, Load, Scout, Scan, Run. It's that simple.

Scout-and-Scan Advantages

- Internal camera for sample viewing
- Recipe control (set, save, recall)
- Multiple energies
- Multiple samples with Autoloader option
- Micropositioning capability with a simple mouse click

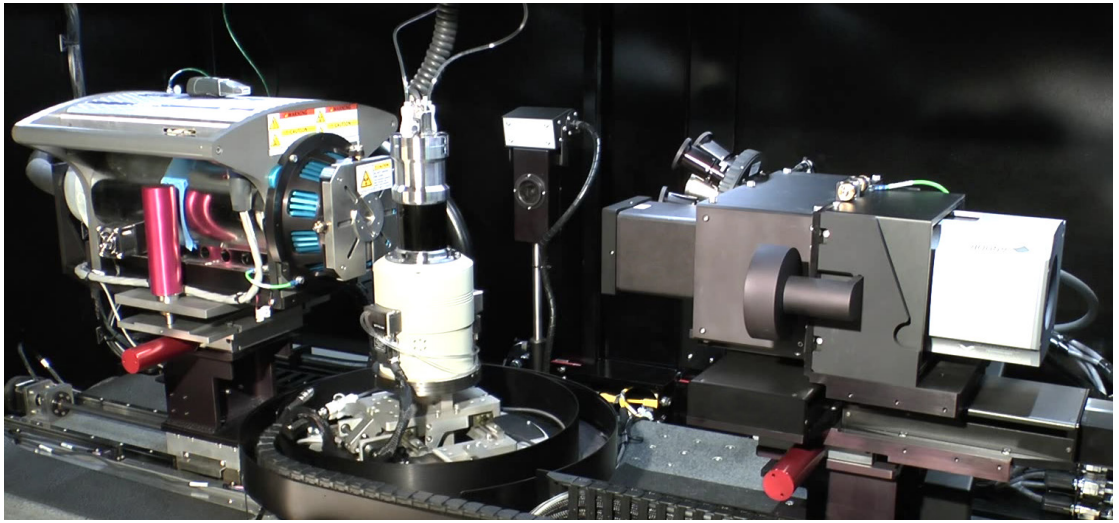
Your Insight into the Technology Behind It

Enhance Your Experimental Possibilities by Adding the ZEISS *In Situ* Interface Kit to Your XRM

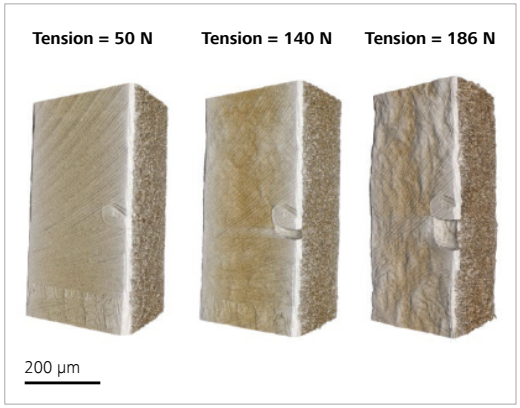
Continuing to push the limits for scientific advancement, ZEISS Xradia Versa solutions have evolved to provide you with the industry's premier 3D imaging solution for the widest variety of *in situ* rigs, from high pressure flow cells to tension, compression, and thermal stages.

ZEISS XRM uniquely enable the most advanced *in situ* experiments. These studies require samples to be further away from the X-ray source to accommodate various types of *in situ* rigs. On traditional microCT systems, this significantly limits the resolution achievable for your samples. ZEISS XRM are uniquely equipped with dual-stage magnification architecture with RaaD technology that enables the highest resolution for *in situ* imaging.

You can add the optional *In Situ* Interface Kit to all ZEISS Xradia Versa instruments. Contents include a mechanical integration kit, a robust cabling guide and other facilities (feed-throughs) along with recipe-based software that simplifies your operation from within the ZEISS Scout-and-Scan user interface. Experience the highest level of stability, flexibility, and controlled integration of *in situ* devices on the ZEISS Xradia Versa, which benefit from an optical architecture that doesn't compromise resolution in variable environmental conditions.



Making the industry's best in situ *solution even better:* In situ *kit tracking with Deben thermomechanical stage.*
In situ *kit available for all Versa systems; image here is representative of the Xradia 510 Versa.*



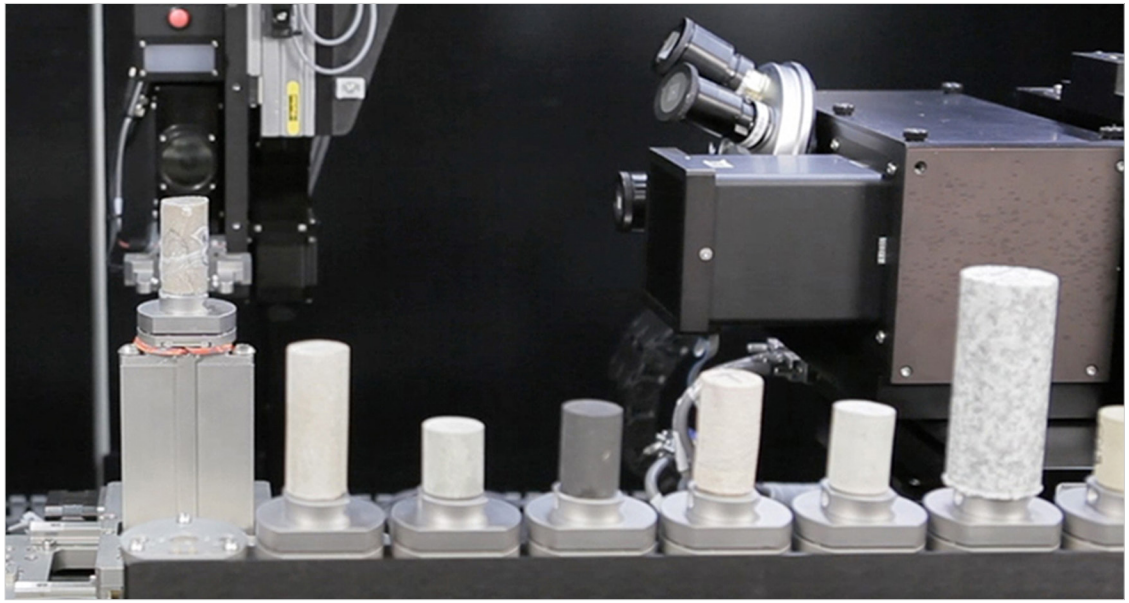
Tensile testing of a steel laser weld under increasing load. The data reveal a crack initiating and propagating from a rough surface imperfection, as well as the elongation of internal voids. Sample courtesy of Sandia National Laboratories.

Your Insight into the Technology Behind It

Autoloader to Increase Your Sample Handling Efficiency

Maximize your instrument's utilization by minimizing user intervention with the optional ZEISS Autoloader, available for all instruments in the ZEISS Xradia Versa series of submicron 3D X-ray microscopes. Reduce the frequency of user interaction and increase productivity by enabling multiple jobs to run. Load up to 14 sample stations, which can support up to 70 samples, queue, and allow to run all day, or off-shift.

The software provides you with the flexibility to re-order, cancel, or stop the queue to insert a high priority sample at any time. An e-mail/text notification feature in the Scout-and-Scan user interface provides timely updates on queue progress. Autoloader also enables a workflow solution for high volume repetitive scanning of like samples.

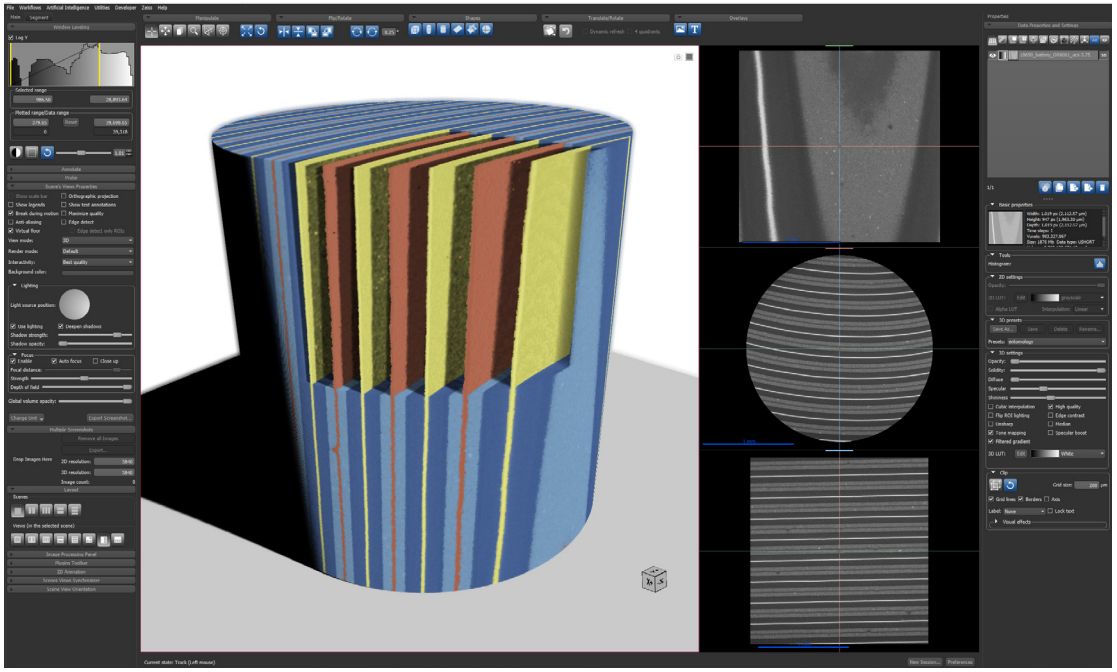


Autoloader option enables you to program up to 14 samples at a time to run sequentially.

Your Insight into the Technology Behind It

Dragonfly Pro: Your Visual Pathway to Quantitative Answers

Dragonfly Pro is advanced 3D visualization and analysis software from Object Research Systems (ORS), and offered exclusively by ZEISS for processing SEM, FIB-SEM, and XRM data. Using advanced visualization techniques and state-of-the-art volume rendering, Dragonfly Pro enables high definition exploration into the details and properties of your datasets. You can register multiple datasets within the same workspace, and easily manipulate your 2D and 3D data with an extensive image processing feature set.



Full featured 3D visualization and data analysis platform

- Find quantitative answers with powerful yet intuitive segmentation and analytical tools
- Create compelling visual media

Engineered to support the needs of microscopists

- A common workspace for integrating multi-scale correlative microscopy, spanning cm to nm
- Simple, intuitive user interface
- Customizable with Python

Process data acquired by ZEISS microscopes

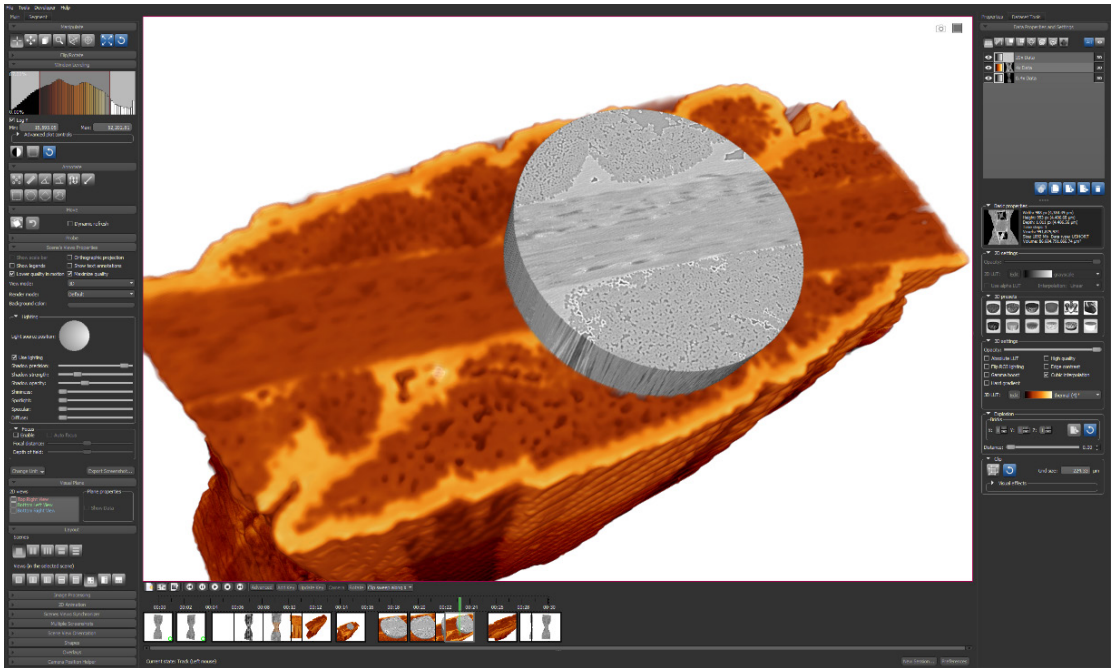
- Read and write various formats including .txm and .czi
- Auto-process and apply macros to automate workflow
- Offered exclusively through ZEISS

Expand the software through optional modules

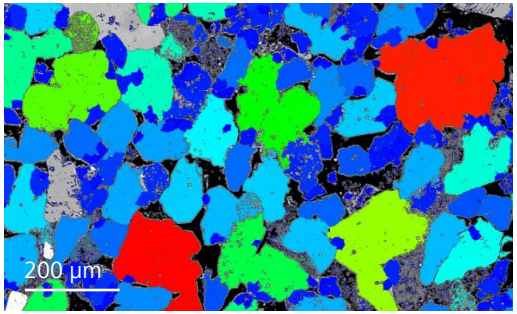
- Deep Learning for advanced segmentation
- Bone Analysis for accurate specialized metrics

Your Insight into the Technology Behind It

Dragonfly Pro from ORS is a configurable software package. You can tailor the tools that are optimal to your workflow, and choose from plug-ins that allow you to control registration, map differences, and customize appearance. Dragonfly Pro also supports regular and unstructured surface meshes, and contains advanced editing tools to create regions of interest from a mesh and vice versa. With the Plug-In Development Kit (PDK), you can leverage the Dragonfly Pro core technology to quickly build specialized workflows.



Tailor the tools that are optimal to your workflow: choose plug-ins that allow you to control registration, map differences, and customize appearance. Ceramic matrix composite, imaged on a ZEISS Xradia Versa microscope. Sample courtesy of Dr. David Marshall, University of Colorado, USA.



Compute morphometric properties to visualize quantitative answers: Sandstone imaged by SEM showing volume distribution of grains in sandstone. Courtesy of Imperial College, UK.

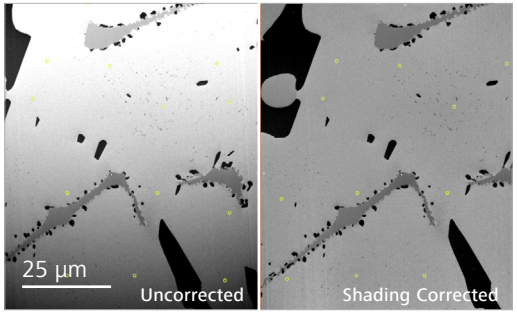


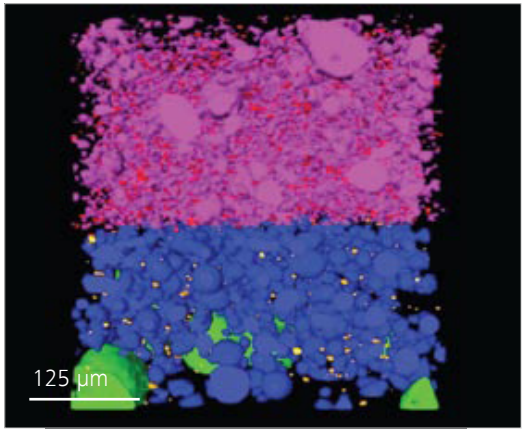
Image filtering: Correct shading, denoise. Nickel carbide alloy imaged by Crossbeam FIB-SEM. Dataset courtesy of P. Bala, AGH University, Poland.

Tailored Precisely to Your Applications

	Task	ZEISS Xradia 410 Versa offers
Materials Research	Expand your materials research capabilities from visualizing cracks in soft composite materials to measuring porosity in steel, all with a single system Perform *in situ* studies by imaging under varying conditions such as tensile, compression, dessication, wetting and temperature variations	View into deeply buried microstructures that may be unobservable with 2D surface imaging such as optical microscopy, SEM, and AFM You have the ability to maintain resolution at a distance for *in situ* imaging experiments, allowing you to study a wide variety of sample sizes and shapes using various *in situ* apparatus. With the nondestructive nature of X-ray, you can additionally understand the impact of these varying conditions over time.
Life Sciences	Quantify osteocyte properties for bone morphology, map neural networks, study vasculature, and understand development of bio structures	Leverage the highest resolution and highest contrast for exploring unstained and stained hard and soft tissues
Raw Materials	Characterize and quantify pore structure, analyze mineral liberation efforts, study carbon sequestration effectiveness	Experience the most accurate 3D, submicron characterization of rock pore structures for digital rock simulations and perform *in situ* multiphase fluid flow studies
Semiconductor and Electronics	Optimize your processes and analyze failures	Use non-destructive submicron imaging of intact packages for defect localization and characterization, complementing or replacing physical cross-sectioning
Battery and Energy Storage	Analyze failures and perform quality inspections of separator and electrodes for defects and inclusions; track aging mechanisms	Use non-destructive 4D *in situ* imaging of intact energy materials without destroying the functionality of the device or disturbing the intricate internal structures
Manufacturing Technology	Analyze internal tomographies of 3D printed parts	Use Scout-and-Zoom to identify a specific region of interest for investigation, and high resolution imaging to see fine details such as un-melted particles, high-Z inclusions, and small voids, without any sample manipulation

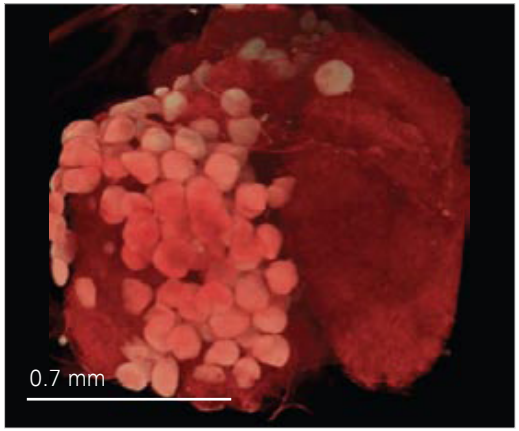
ZEISS Xradia 410 Versa at Work

Materials Research



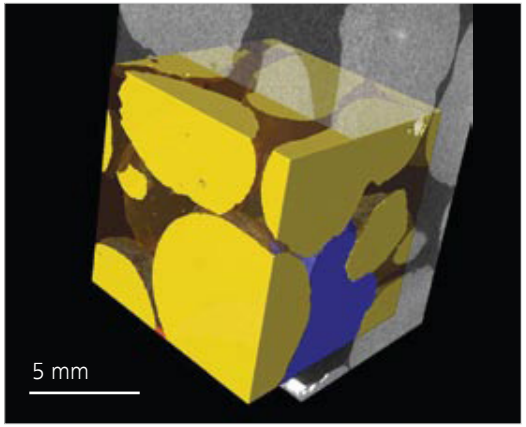
Composite material of polyurethane, EDPM, metal oxides and high melting explosive

Life Sciences



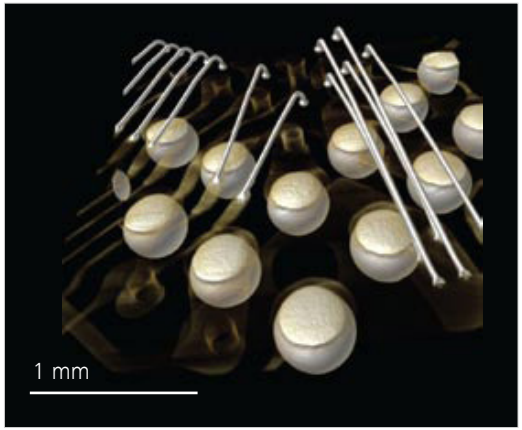
Murine breast tissue

Raw Materials



Unstained water in Ottawa sand, imaged in a 12.5 mm diameter aluminum tube

Electronics



Large flip chip (10×10×1 mm) imaged at high resolution

Your Flexible Imaging Solution

1 X-ray Microscope
- ZEISS Xradia 410 Versa with Resolution at a Distance

2 Source Options
- Light materials, closed reflection source (20 – 90 kV, maximum 8 W)
- High energy, closed reflection source (40 – 150 kV, maximum 10 W)
- High power, closed reflection source (40 – 150 kV, maximum 30 W)

3 Contrast-optimized Detectors
- Innovative dual-stage detector system with detector turret of multiple objectives at different magnifications with optimized scintillators for highest contrast
- 2k x 2k pixel noise suppressed charge-coupled detector

4 System Stability for Best Imaging
- Granite base vibrational isolation
- Thermal environment stabilization
- Low noise detector
- Proprietary stabilization mechanisms

5 System Flexibility for Diverse Range of Sample Sizes
- Variable scanning geometry
- Tunable voxel sizes
- Absorption contrast mode
- Phase contrast mode
- Wide Field Mode (WFM) for increased lateral tomography volume with 0.4X objective
- Vertical stitching for joining multiple tomographies vertically

6 Autoloader Option
- Maximize productivity by reducing user intervention
- Programmable handling of up to 14 samples
- Automated workflows for high volume, repetitive scanning

7 Sample Stage
- Ultra-high precision 4-degrees of freedom sample stage 25 kg sample mass capacity

8 X-ray Filters
- Single filter holder
- Set of 12 filters included
- Custom filters available by special order

9 Advanced Reconstruction Toolbox with Options for Enhanced Performance
- ZEISS DeepRecon Pro with AI-based reconstruction technology for up to 10× throughput or superior image quality on Unique, Semi-repetitive, and Repetitive sample workflows
- ZEISS OptiRecon with iterative reconstruction for up to 4× throughput or enhanced image quality
- ZEISS PhaseEvolve for enhanced contrast and segmentation in low-medium density sample or high resolution imaging applications

10 *In Situ* and 4D Solutions
- Resolution at a Distance (RaaD) enables superior *in situ* imaging
- Integrated *in situ* recipe control for Deben stages
- *In situ* interface kit option
- Custom *in situ* flow interface kit by special order

11 Instrument Workstation
- Power workstation with fast reconstruction
- Single CUDA-based GPU
- Multi-core CPU
- 24" display monitor

12 Software
- Acquisition: Scout-and-Scan Control System
- Reconstruction: XMReconstructor
- Viewer: XM3DViewer
- Compatible with wide range of 3D viewers and analysis software programs
- ORS Dragonfly Pro for 3D visualization and analysis (optional)

Technical Specifications

Imaging	ZEISS Xradia 410 Versa	ZEISS Xradia 510 Versa	ZEISS Xradia 610 Versa	ZEISS Xradia 620 Versa
Spatial Resolution [a]	0.9 µm	0.7 µm	0.5 µm	0.5 µm
Resolution at a Distance (RaaD) [a,b] **(at 50 mm working distance)**	1.5 µm	1.0 µm	1.0 µm	1.0 µm
Minimum Achievable Voxel [c] **(Voxel size at sample at maximum magnification)**	100 nm	70 nm	40 nm	40 nm
X-ray Source				
Architecture	Sealed Reflection	Sealed Transmission	Sealed Transmission, Fast Activation	Sealed Transmission, Fast Activation
Voltage Range	20- 90 kV, 40-150 kV (Optional)	30 – 160 kV	30 – 160 kV	30 – 160 kV
Maximum Output	8 W, 10 W/30 W (Optional)	10 W	25 W	25 W
Detector System				
ZEISS X-ray microscopes feature an innovative detector turret with multiple objectives at different magnifications. Each objective features optimized scintillators that deliver the highest absorption contrast details.				
Standard Objectives	0.4×, 4×, 10×, 20×	0.4×, 4×, 20×	0.4×, 4×, 20×	0.4×, 4×, 20×
Optional Objectives	40×	40×, Flat Panel Extension (FPX)	40×, Flat Panel Extension (FPX)	40×, Flat Panel Extension (FPX)
Stages				
Sample Stage (load capacity)	25 kg	25 kg	25 kg	25 kg
Sample Stage Travel (x, y, z)	50, 100, 50 mm	50, 100, 50 mm	50, 100, 50 mm	50, 100, 50 mm
Sample Size Limit	300 mm diameter	300 mm diameter	300 mm diameter	300 mm diameter

[a] Spatial resolution measured with ZEISS Xradia 2D resolution target, normal field mode, optional 40× objective.
[b] RaaD working distance defined as clearance around axis of rotation.
[c] Voxel is a geometric term that contributes to but does not determine resolution, and is provided here only for comparison. ZEISS specifies resolution via spatial resolution, the true overall measurement of instrument resolution.

Technical Specifications

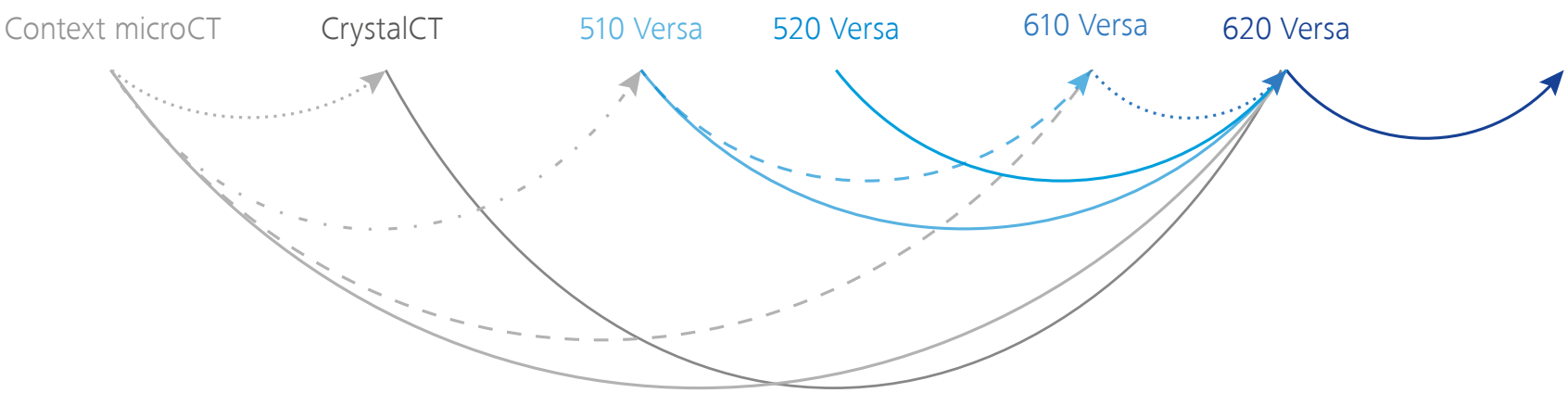
Features	ZEISS Xradia 410 Versa	ZEISS Xradia 510 Versa	ZEISS Xradia 610 Versa	ZEISS Xradia 620 Versa
Scout-and-Scan Control System	■	■	■	■
Scout-and-Zoom	■	■	■	■
Vertical Stitch	■	■	■	■
XRM Python API	■	■	■	■
Automated Filter Changer (AFC)				■
High Aspect Ratio Tomography (HART)				■
Dual Scan Contrast Visualizer (DSCoVer)				■
ZEISS LabDCT for Diffraction Contrast Tomography				Optional
Wide Field Mode	0.4×	0.4×	0.4×	0.4× and 4×
GPU CUDA-based Reconstruction	Single	Single	Dual	Dual
ZEISS SmartShield		■	■	■
ZEISS Autoloader	Optional	Optional	Optional	Optional
In Situ Interface Kit	Optional	Optional	Optional	Optional
ZEISS OptiRecon	Optional	Optional	Optional	Optional
ZEISS DeepRecon Pro	Optional	Optional	Optional	Optional
ZEISS PhaseEvolve	Optional	Optional	Optional	Optional
ZEISS ZEN Intellesis	Optional	Optional	Optional	Optional
ORS Dragonfly Pro	Optional	Optional	Optional	Optional
ZEISS Metrology Extension (MTX)				Optional

ZEISS Customer Focus: Continuous Improvement and Upgradeability

Protect Your Investment. ZEISS Xradia 3D X-ray systems deliver unprecedented extensibility. ZEISS offers unrelenting support to ensure you are not left behind.

Most ZEISS Xradia X-ray microscopes are designed to be upgradeable and extensible with future innovations and developments so that your initial investment is protected. This ensures your microscope capabilities evolve with advancements in leading technology. This is one of the key differentiators in the 3D X-ray imaging industry.

From ZEISS Xradia Context microCT, to ZEISS Xradia 510/520 Versa, and up to ZEISS Xradia 610/620 Versa, you can field-convert your system to the latest X-ray microscope products. In addition to instrument conversions at your facility, new modules are being continuously developed that will enhance your instrument to provide advanced capabilities such as *in situ* sample environments, unique imaging modalities, and productivity-enhancing modules. Also, periodic major software releases include important new features that are made available to existing instruments, thereby enhancing and extending the capabilities of your research.



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